

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







High-Speed USB 2.0 (480 Mbps) DPDT Switches

The NL3S2223 is a DPDT switch optimized for high–speed USB 2.0 applications within portable systems. It features ultra–low on capacitance, $C_{\rm ON} = 5.5$ pF (typ), and a bandwidth above 950 MHz. It is optimized for applications that use a single USB interface connector to route multiple signal types. The $C_{\rm ON}$ and $R_{\rm ON}$ of both channels are suitably low to allow the NL3S2223 to pass any speed USB data or audio signals going to a moderately resistive terminal such as an external headset. The device is offered in a UQFN10 1.4 mm x 1.8 mm package.

Features

- Optimized Flow-Through Pinout
- R_{ON} : 5.0 Ω Typ @ V_{CC} = 4.2 V
- C_{ON} : 5.5 pF Typ @ V_{CC} = 3.3 V
- V_{CC} Range: 1.65 V to 4.5 V
- Typical Bandwidth: 950 MHz
- 1.4 mm x 1.8 mm x 0.50 mm UQFN10
- OVT on Common Signal Pins D+/D- up to 5.25 V
- 8 kV HBM ESD Protection on All Pins
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- High Speed USB 2.0 Data
- Mobile Phones
- Portable Devices

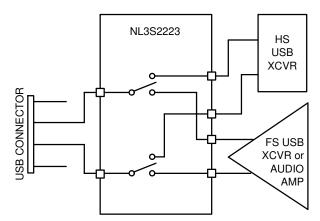


Figure 1. Application Diagram



ON Semiconductor®

www.onsemi.com

MARKING DIAGRAM



UQFN10 CASE 488AT



U3 = Device Code

M = Date Code

Pb-Free Device

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|---------------------|-----------------------|
| NL3S2223MUTBG | UQFN10 (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

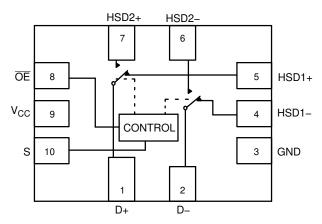


Figure 2. Pin Connections and Logic Diagram (Top View)

Table 1. PIN DESCRIPTION

| Pin | Function |
|---------------------------------------|---------------|
| S | Control Input |
| ŌĒ | Output Enable |
| HSD1+, HSD1-, HSD2+, HSD2-, D+, D- | Data Ports |

Table 2. TRUTH TABLE

| ŌĒ | S | HSD1+, HSD1– | HSD2+, HSD2– |
|----|---|-----------------|-----------------|
| 1 | X | OFF | OFF |
| 0 | 0 | ON | OFF |
| 0 | 1 | OFF | ON |

MAXIMUM RATINGS

| Symbol | Pins | Parameter | Value | Unit |
|----------------------|-------------------------|---|--------------------------|---------|
| V _{CC} | V _{CC} | Positive DC Supply Voltage | -0.5 to +5.5 | V |
| V _{IS} | HSDn+, HSDn- | Analog Signal Voltage | -0.5 to $V_{CC} + 0.3$ | V |
| | D+, D- | | -0.5 to +5.25 | |
| V _{IN} | S, OE | Control Input Voltage, Output Enable Voltage | -0.5 to +5.5 | V |
| I _{CC} | V_{CC} | Positive DC Supply Current | 50 | mA |
| T _S | | Storage Temperature | -65 to +150 | °C |
| I _{IS_CON} | HSDn+, HSDn-, D+, D- | Analog Signal Continuous Current–Closed Switch | ±300 | mA |
| I _{IS_PK} | HSDn+, HSDn-, D+, D- | Analog Signal Continuous Current 10% Duty Cycle | ± 500 | mA |
| I _{IN} | S, OE | Control Input Current, Output Enable Current | ±20 | mA |
| V _{ESD} | HBM MM | Human Body Model Machine Model | 8 400 | kV V |
| I _{Latchup} | | Latchup Performance | ±100 | mA |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Pins | Parameter | Min | Max | Unit |
|-----------------|------------------|--|------|-----------------|------|
| V _{CC} | | Positive DC Supply Voltage | 1.65 | 4.5 | V |
| V _{IS} | HSDn+, HSDn- | Analog Signal Voltage | GND | V _{CC} | V |
| | D+, D- |] | GND | 4.5 | |
| V _{IN} | S, OE | Control Input Voltage, Output Enable Voltage | GND | V _{CC} | V |
| T _A | | Operating Temperature | -40 | +85 | °C |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

CONTROL INPUT, OUTPUT ENABLE VOLTAGE (Typical: T = 25°C)

| | | | | | -40°C to +85°C | | | |
|-----------------|------------------|---|---------------------------|---------------------|--------------------|-----|--------------------|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| V _{IH} | S, ŌE | Control Input, Output Enable HIGH Voltage (See Figure 11) | | 2.7 3.3 4.2 | 1.25 1.3 1.4 | - | - | ٧ |
| V _{IL} | S, OE | Control Input, Output Enable LOW Voltage (See Figure 11) | | 2.7 3.3 4.2 | ı | - | 0.35 0.4 0.5 | V |
| I _{IN} | S, OE | Current Input, Output Enable Leakage Current | $0 \le V_{IS} \le V_{CC}$ | 1.65 – 4.5 | - | _ | ±0.1 | μΑ |

SUPPLY CURRENT AND LEAKAGE (Typical: T = 25°C, V_{CC} = 3.3 V)

| | | | | | -40°C to +85°C | | | |
|------------------|-----------------|------------------------------|--|-------------------------|----------------|--------|------------|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| I _{CC} | V _{CC} | Quiescent Supply Current | $ 0 \le V_{IS} \le V_{CC}; \ I_D = 0 \ A $ $ 0 \le V_{IS} \le V_{CC} - 0.5 \ V $ | 1.65 – 3.6 3.6 – 4.5 | - - | - - | 0.1 0.1 | μΑ |
| I _{OZ} | | OFF State Leakage | $0 \le V_{IS} \le V_{CC}$ | 1.65 – 4.5 | - | ±0.1 | ±0.5 | μΑ |
| l _{OFF} | D+, D- | Power OFF Leakage Current | $0 \le V_{IS} \le V_{CC}$ | 0 | - | - | ±0.5 | μΑ |

LIMITED V_{IS} SWING ON RESISTANCE (Typical: T = 25°C)

| | | | | | –40°C to +85°C | | | |
|-------------------|------|---|--|---------------------|----------------|----------------------|-------------------|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| R _{ON} | | On–Resistance (Note 1) | I _{ON} = 8 mA V _{IS} = 0 V to 0.4 V | 2.7 3.3 4.2 | - | 6.0 5.5 5.0 | 8.6 7.6 7.0 | Ω |
| R _{FLAT} | | On–Resistance Flatness (Notes 1 and 2) | I _{ON} = 8 mA V _{IS} = 0 V to 0.4 V | 2.7 3.3 4.2 | - | 0.55 0.30 0.20 | - | Ω |
| ΔR _{ON} | | On–Resistance Matching (Notes 1 and 3) | I _{ON} = 8 mA V _{IS} = 0 V to 0.4 V | 2.7 3.3 4.2 | - | 0.60 0.60 0.60 | - | Ω |

^{1.} Guaranteed by design.

FULL V_{IS} SWING ON RESISTANCE (Typical: T = 25°C)

| | | | | | -40°C to +85°C | | | |
|-------------------|------|---|--|---------------------|----------------|----------------------|----------------------|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| R _{ON} | | On–Resistance | I _{ON} = 8 mA V _{IS} = 0 V to V _{CC} | 2.7 3.3 4.2 | - | 10 8.0 7.0 | 13.5 9.75 8.50 | Ω |
| R _{FLAT} | | On–Resistance Flatness (Notes 4 and 5) | I _{ON} = 8 mA V _{IS} = 0 V to V _{CC} | 2.7 3.3 4.2 | - | 4.5 3.0 2.5 | - | Ω |
| ΔR _{ON} | | On-Resistance (Note 4 and 6) | I _{ON} = 8 mA V _{IS} = 0 V to V _{CC} | 2.7 3.3 4.2 | - | 0.60 0.60 0.60 | - | Ω |

^{4.} Guaranteed by design.

Flatness is defined as the difference between the maximum and minimum value of On–Resistance as measured over the specified analog signal ranges.

^{3.} $\Delta \ddot{R}_{ON} = \ddot{R}_{ON(max)} - R_{ON(min)}$ between HSD1+ and HSD1- or HSD2+ and HSD2-.

Flatness is defined as the difference between the maximum and minimum value of On–Resistance as measured over the specified analog signal ranges.

^{6.} $\Delta R_{ON} = R_{ON(max)} - R_{ON(min)}$ between HSD1+ and HSD1- or HSD2+ and HSD2-.

AC ELECTRICAL CHARACTERISTICS

TIMING/FREQUENCY (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 Ω , C_L = 35 pF, f = 1 MHz)

| | | | | | -40°C to +85°C | | | |
|------------------|----------------|--|-----------------------|---------------------|----------------|------|------|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| t _{ON} | Closed to Open | Turn-ON Time (See Figures 4 and 5) | | 1.65 – 4.5 | - | 13.0 | 30.0 | ns |
| toff | Open to Closed | Turn-OFF Time (See Figures 4 and 5) | | 1.65 – 4.5 | - | 12.0 | 25.0 | ns |
| T _{BBM} | | Break-Before-Make Time (See Figure 3) | | 1.65 – 4.5 | 2.0 | - | - | ns |
| BW | | -3 dB Bandwidth (See Figure 10) | C _L = 5 pF | 1.65 – 4.5 | - | 950 | - | MHz |

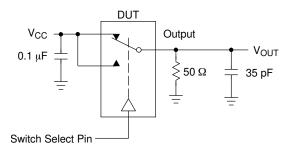
 $\textbf{ISOLATION} \; (\text{Typical: T} = 25^{\circ}\text{C}, \, \text{V}_{CC} = 3.3 \; \text{V}, \, \text{R}_{L} = 50 \; \Omega, \, \text{C}_{L} = 5 \; \text{pF})$

| | | | | | -40°C to +85°C | | | |
|-------------------|----------------|-----------------------------------|-----------------|---------------------|----------------|-----|-----|------|
| Symbol | Pins | Parameter | Test Conditions | V _{CC} (V) | Min | Тур | Max | Unit |
| O _{IRR} | Open | OFF-Isolation (See Figure 6) | f = 240 MHz | 1.65 – 4.5 | - | -22 | - | dB |
| X _{TALK} | HSDn+ to HSDn- | Non-Adjacent Channel Crosstalk | f = 240 MHz | 1.65 – 4.5 | - | -24 | - | dB |

 $\textbf{CAPACITANCE} \; (\text{Typical: T} = 25^{\circ}\text{C}, \; V_{CC} = 3.3 \; \text{V}, \; R_L = 50 \; \Omega, \; C_L = 5 \; \text{pF})$

| | | | | -40 | 0°C to +85 | 5°C | |
|------------------|-------------------|----------------------------|--|-----|------------|-----|------|
| Symbol | Pins | Parameter | Test Conditions | Min | Тур | Max | Unit |
| C _{IN} | S, OE | Control Pin, Output Enable | V _{CC} = 0 V, f = 1 MHz | - | 1.5 | - | pF |
| | | Input Capacitance | V _{CC} = 0 V, f = 10 MHz | _ | 1.0 | _ | |
| C _{ON} | D+ to HSD1+ or | | $V_{CC} = 3.3 \text{ V}; \overline{OE} = 0 \text{ V}, f = 1 \text{ MHz}$ S = 0 V or 3.3 V | _ | 5.5 | _ | |
| | HSD2+ | | V _{CC} = 3.3 V; OE = 0 V, f = 10 MHz S = 0 V or 3.3 V | - | 5.5 | - | |
| | | | V _{CC} = 3.3 V; OE = 0 V, f = 240 MHz S = 0 V or 3.3 V | - | 5 | - | |
| C _{OFF} | HSD1n or HSD2n | OFF Capacitance | $\begin{array}{c} V_{CC} = V_{ S} = 3.3 \text{ V}; \\ \overline{OE} = 3.3 \text{ V or } (\overline{OE} = 0 \text{ V}, \text{ S} = 3.3 \text{ V or } 0 \text{ V}), \\ f = 1 \text{ MHz} \end{array}$ | _ | 3.8 | - | pF |
| | | | $ \begin{array}{c} V_{CC} = V_{IS} = 3.3 \text{ V}; \\ \overline{OE} = 3.3 \text{ V or } (\overline{OE} = 0 \text{ V}, \text{ S} = 3.3 \text{ V or } 0 \text{ V}), \\ f = 10 \text{ MHz} \end{array} $ | - | 2.0 | - | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



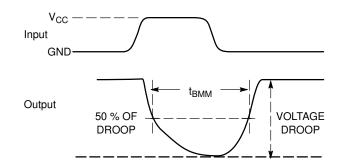
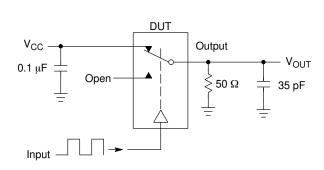


Figure 3. t_{BBM} (Time Break-Before-Make)



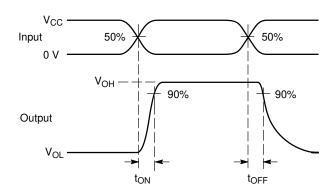
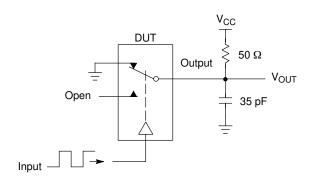


Figure 4. t_{ON}/t_{OFF}



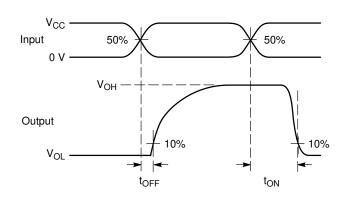
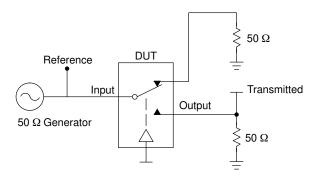


Figure 5. t_{ON}/t_{OFF}



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. $V_{\rm ISO}$, Bandwidth and $V_{\rm ONL}$ are independent of the input signal direction.

$$\begin{split} &V_{ISO} = \text{Off Channel Isolation} = 20 \text{ Log} \left(\frac{V_{OUT}}{V_{IN}} \right) \text{for V}_{IN} \text{ at 100 kHz} \\ &V_{ONL} = \text{On Channel Loss} = 20 \text{ Log} \left(\frac{V_{OUT}}{V_{IN}} \right) \text{ for V}_{IN} \text{ at 100 kHz to 50 MHz} \end{split}$$

Bandwidth (BW) = the frequency 3 dB below V_{ONL}

 V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω

Figure 6. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V_{ONL}

DETAILED DESCRIPTION

High Speed (480Mbps) USB 2.0 Optimized

The NL3S2223 is a DPDT switch designed for USB applications within portable systems. The R_{ON} and C_{ON} of both switches are maintained at industry–leading low levels in order to ensure maximum signal integrity for USB 2.0 high speed data communication. The NL3S2223 switch can be used to switch between high speed (480Mbps) USB signals and a variety of audio or data signals such as full speed USB, UART or even a moderately resistive audio terminal.

Over Voltage Tolerant

The NL3S2223 features over voltage tolerant I/O protection on the common signal pins D+/D-. This allows the switch to interface directly with a USB connector. The D+/D- pins can withstand a short to V_{BUS} , up to 5.25 V, continuous DC current for up to 24 hours as specified in the USB 2.0 specification. This protection is achieved without the need for any external resistors or protection devices.

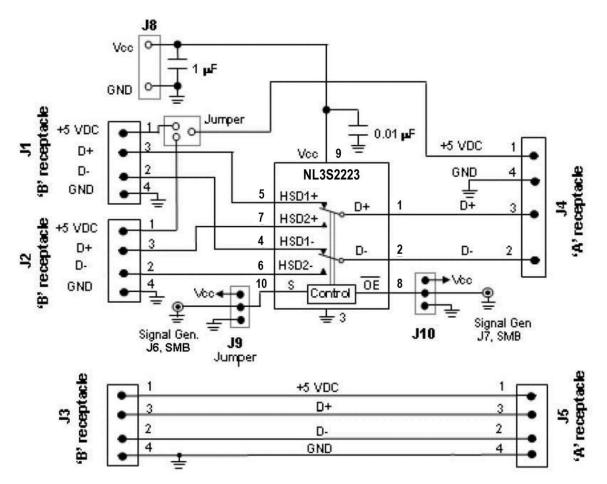


Figure 7. Board Schematic

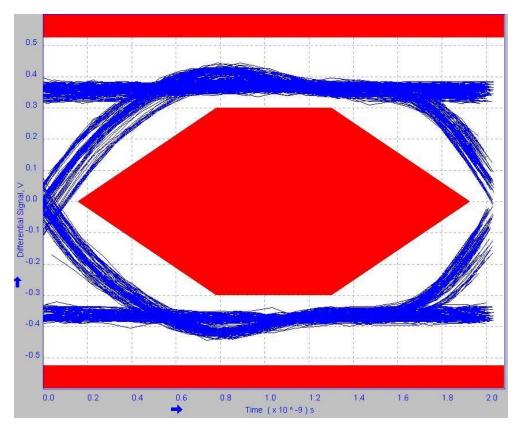


Figure 8. Signal Quality

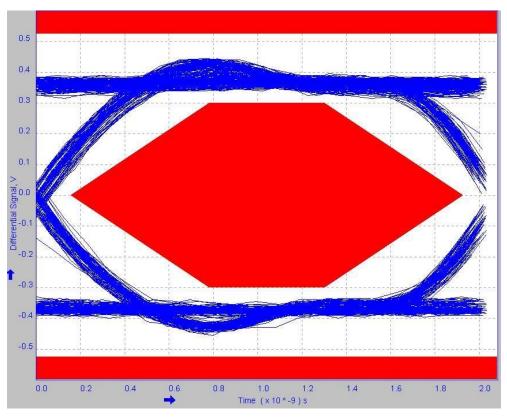


Figure 9. Near End Eye Diagram

| Near End Test Data: | | | | | Min | Max |
|---------------------|--------------------------|--------|-------|----|---------|---------|
| | Consecutive jitter range | -54.37 | 73.21 | ps | –200 ps | +200 ps |
| Std. | Paired JK jitter range | -59.14 | 59.56 | ps | | |
| | Paired KJ jitter range | -50.79 | 34.57 | ps | | |
| | Consecutive jitter range | -74.43 | 81.65 | ps | –200 ps | +200 ps |
| N.C. | Paired JK jitter range | -61.60 | 58.55 | ps | | |
| | Paired KJ jitter range | -55.31 | 48.43 | ps | | |
| | Consecutive jitter range | -82.55 | 80.33 | ps | –200 ps | +200 ps |
| N.O. | Paired JK jitter range | -53.50 | 71.65 | ps | | |
| | Paired KJ jitter range | -62.60 | 47.30 | ps | | |

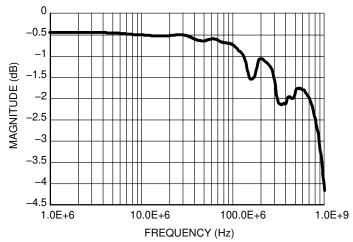


Figure 10. Magnitude vs. Frequency @ V_{CC} = 3.3 V, All Temperatures

I_{CC} Leakage Current as a Function of V_{IN} Voltage (25°C)

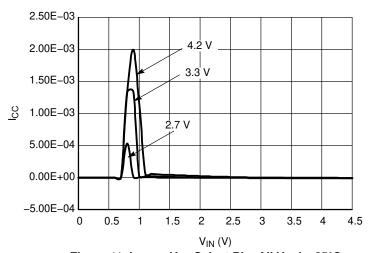


Figure 11. I_{CC} vs. V_{IN} , Select Pin, All V_{CC} 's, 25°C

PACKAGE DIMENSIONS

UQFN10 1.4x1.8, 0.4P CASE 488AT **ISSUE A EDGE OF PACKAGE** NOTES Α 1. DIMENSIONING AND TOLERANCING PER ASME D Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. E PIN 1 REFERENCE **DETAIL A MILLIMETERS** 2X | | 0.10 | C **Bottom View** MIN MAX 0.45 0.60 (Optional) 0.00 0.05 0.127 REF 0.10 C A3 MOLD CMPD 0.15 0.25 В EXPOSED Cu 1.40 BSC **TOP VIEW** Е 1.80 BSC 0.40 BSC 0.30 0.50 е 0.05 C **A3** 0.00 0.15 0.40 0.60 Α1 0.05 C **DETAIL B** Α1 SEATING PLANE Side View **MOUNTING FOOTPRINT*** SIDE VIEW (Optional) 1.700 0.563 0.0669 0.0221 0.663 0.0261 0.200 0.0079 10 X 0.10 C A B 2.100 0.05 С NOTE 3 0.0827 **BOTTOM VIEW** 0.400 0.0157 **PITCH** 10 X 0.225 0.0089 SCALE 20:1

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

0

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative